PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
QING ZHAO	03/18/2014
YAKUN SUN	08/04/2014
YI-LING CHAO	03/17/2014
LEILEI SONG	03/17/2014
HUI-LING LOU	10/28/2014

RECEIVING PARTY DATA

Name:	MARVELL SEMICONDUCTOR, INC.
Street Address:	5488 MARVELL LANE
City:	SANTA CLARA
State/Country:	CALIFORNIA
Postal Code:	95054

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	14218876

CORRESPONDENCE DATA

Fax Number: (408)222-2755

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

Phone: 408-222-2500
Email: sherir@marvell.com
Correspondent Name: KELVIN VIVIAN

Address Line 1: 5488 MARVELL LANE

Address Line 4: SANTA CLARA, CALIFORNIA 95054

ATTORNEY DOCKET NUMBER: MP5093

NAME OF SUBMITTER: KELVIN VIVIAN

SIGNATURE: /Kelvin Vivian/

DATE SIGNED: 06/22/2016

Total Attachments: 8

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PATENT REEL: 038989 FRAME: 0271

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ASSIGNMENT

For good and valuable consideration, the receipt of which is hereby acknowledged, I, the undersigned,

Qing Zhao, Yakun Sun, Yi-Ling Chao, Leilei Song, and Hui-Ling Lou

who have created a certain invention for which an application for United States Letters Patent was executed by me concurrently herewith and entitled:

IN-DEVICE COEXISTENCE OF WIRELESS COMMUNICATION TECHNOLOGIES

Do hereby sell, assign and transfer to Marvell Semiconductor, Inc., a corporation of California, having a place of business at 5488 Marvell Lane, Santa Clara, CA 95054, its successors, assigns, and legal representatives, the full and exclusive right to said invention and said application and to any and all inventions described in said application for the United States, its territorial possessions and all foreign countries, and the entire right, title and interest in and to any and all Letters Patent which may be granted therefor in the United States, its territorial possessions and all foreign countries; and in and to any and all continuations-in-part, continuations, divisions, substitutes, reissues, extensions thereof, and all other applications for Letters Patent relating thereto which have been or shall be filed in the United States, its territorial possessions and/or any foreign countries, and all rights, together with all priority rights, under any of the international conventions, unions, agreements, acts, and treaties, including all future conventions, unions, agreements, acts, and treaties;

Do hereby further sell, assign and transfer to Marvell Semiconductor, Inc., its successors, assigns, and legal representatives, the full and exclusive right to United States Provisional Patent Application No. 61/802,901, filed March 18, 2013, entitled "Puncture of Interfered DL Subframes to Facilitate IDC," and to any and all inventions described in said provisional patent application(s) for the United States, its territorial possessions and all foreign countries, and the entire right, title and interest in and to any and all Letters Patent which may be entitled to the benefit thereof in the United States, its territorial possessions and all foreign countries; and in and to any and all continuations-in-part, continuations, divisions, substitutes, reissues, extensions thereof, and all other applications for Letters Patent relating thereto which have been or shall be filed in the United States, its territorial possessions and/or any foreign countries, and all rights, together with all priority rights, under any of the international conventions, unions, agreements, acts, and treaties;

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Covenant with said Assignee, its successors, assigns, or legal representatives that no assignment, grant, mortgage, license or other agreement affecting the rights and property herein conveyed has been made to others by the undersigned, and that full right to convey the same as herein expressed is possessed by the undersigned.

Date: Month/Day/Year
3-18-2014
Date: Month/Day/Year
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Full Name of First Inventor:		*
Qing Zhao		
Inventor's Signature:		Date: Month/Day/Year
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Full Name of Second Inventor:		
Yakun Sun		
Inventor's Signature:	- Recent Re Re Recent	Date: Month/Day/Year
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		* *
Full Name of Third Inventor:		× ·
Yi-Ling Chao		
Inventor's Signature:	***************************************	Date: Month/Day/Year
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***************************************		500-10
Full Name of Fourth Inventor:		
Leilei Song		
Inventor's Signature:	**	Date: Month/Day/Year
		= 1 200000
Full Name of Fifth Inventor:	g.	W 1997
Hui-Ling Lou		
Inventor's Signature:	•••••	Date: Month/Day/Year
4		

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Full Name of First Inventor:	
Qing Zhao	
Inventor's Signature:	Date: Month/Day/Year
Full Name of Second Inventor:	
Yakun Sun	
Inventor's Signature:	Date: Month/Day/Year
Full Name of Third Inventor:	
Yi-Ling Chao	
Inventor's Signature:	Date: Month/Day/Year
14V (-	3/1/2014
Full Name of Fourth Inventor:	
Leilei Song	
Inventor's Signature:	Date: Month/Day/Year
	3/17/2014
Full Name of Fifth Inventor:	
Hui-Ling Lou	
Inventor's Signature:	Date: Month/Day/Year

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Yi-Ling Chao		
Inventor's Signature:	Date: Month/Day/Year	
15. 24.1		
Full Name of Fourth Inventor:		
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Full Name of Fifth Inventor:		
Hui-Ling Lou		
Inventor's Signature:	Date: Month/Day/Year	
(N) ()	10/28/14	